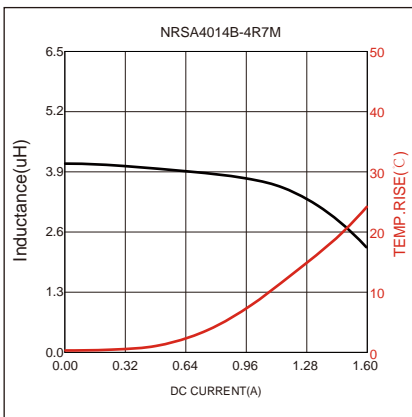
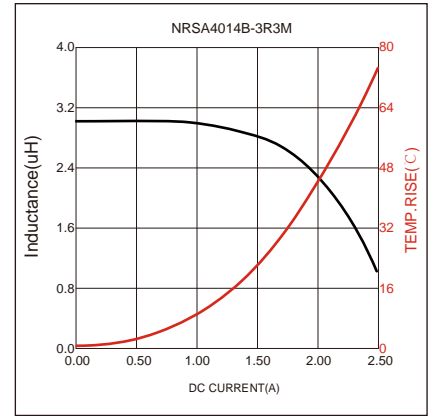
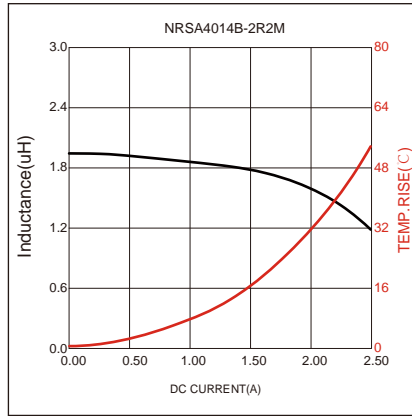
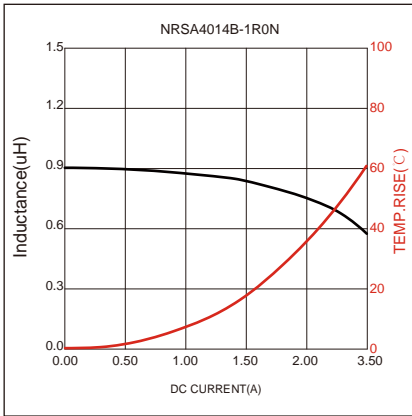






# Typical Electrical Characteristics:





## Soldering Reflow:

Preheat condition: 150 ~200 °C / 60~120 sec.

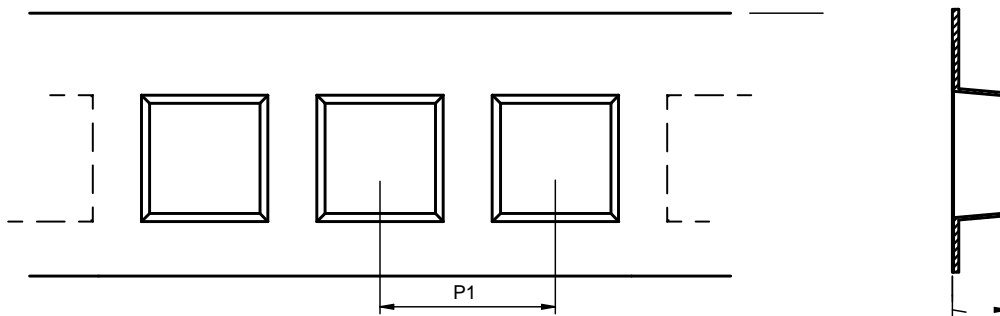
Allowed time above 217 °C : 60~90 sec.

Max temperature: 260 °C .

Allowed Reflow time: 2x max.

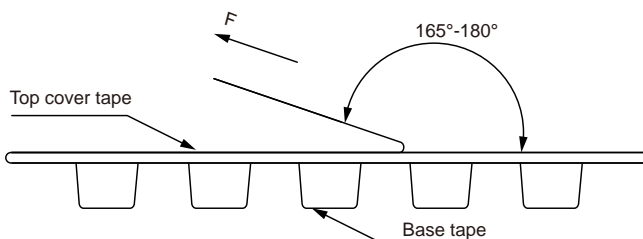
## Packaging Information:

Tape Dimension :



Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
@DE3&" #&4	&Z\$' f " z#	&Z\$' f " z#	#Z' f " z#	&Z' f " z#	*Z' f " z#	#S'Z' f " Z%	#Z&f " z#	#Z)' f " z#	" Z%' f " Z'

Peel force of top cover tape:



FZWbVWxAdUaXfab UahWdSbWeZS^TWi VV " Z%fa #z#) @

